

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SONG-YA CHEN	07/20/2010
RECEIVING PARTY DATA	
Name:	Fu Tai Hua Industry (Shenzhen) Co., Ltd.
Street Address:	Area B, Foxconn Guanlan Technology Park,Dasan Community, Guanlan Sub-District
City:	ShenZhen City, Guangdong Province
State/Country:	CHINA
Name:	HON HAI PRECISION INDUSTRY CO., LTD.
Street Address:	66,CHUNG SHAN ROAD
City:	Tu-Cheng,Taipei Hsien
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12876157
CORRESPONDENCE DATA	
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<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
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Correspondent Name:	Frank R. Niranjan
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Address Line 4:	City of Industry, CALIFORNIA 91789
ATTORNEY DOCKET NUMBER:	US31536
NAME OF SUBMITTER:	Frank R. Niranjan

CH \$40.00 12876157

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PATENT
REEL: 024941 FRAME: 0162

Total Attachments: 2

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ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

- | | | | |
|----|--------------|---------------|----------------------------|
| 1. | SONG-YA CHEN | , residing at | Shenzhen, Guangdong, China |
| 2. | | , residing at | |
| 3. | | , residing at | |
| 4. | | , residing at | |
| 5. | | , residing at | |
| 6. | | , residing at | |
| 7. | | , residing at | |
| 8. | | , residing at | |

hereby sell(s), assign(s) and transfer(s) unto: **FU TAI HUA INDUSTRY (SHENZHEN) CO., LTD.** having a principal place of business at **Area B, Foxconn Guanlan Technology Park, Dasan Community, Guanlan Sub-District, Bao'an District, Shenzhen City, Guangdong Province, P.R.C.** and **HON HAI PRECISION INDUSTRY CO., LTD.** having a principal place of business at **66, Chung Shan Road, Tu-Cheng City, Taipei Hsien, Taiwan, R.O.C.** hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as **ELECTROMAGNETIC INTERFERENCE SPRING CONTACT FOR SHIELDING ELECTROMAGNETIC INTERFERENCE AND ELECTRONIC DEVICE USING SAME** for which the undersigned

[] previously executed --- Ser. No. _____ and filing date of _____
 [x] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection of its title in and to the

1.	<u>SONG-YA CHEN</u> SONG-YA CHEN	<u>Jul. 20, 2010</u> Date
2.	_____	_____ Date
3.	_____	_____ Date
4.	_____	_____ Date
5.	_____	_____ Date
6.	_____	_____ Date
7.	_____	_____ Date
8.	_____	_____ Date
9.	_____	_____ Date